

SUPPORTING INFORMATION

**Suppressing Ag₂Te Nanoprecipitates for Enhancing
Thermoelectric Efficiency of AgSbTe₂**

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Table S1. Rietveld refinement of XRD in Figure S2 for all off-stoichiometry samples without thermal annealing

sample	UC volume	Fraction (%)	UC volume	Fraction (%)	Chi ²
Ag _{0.91} Sb _{1.09} Te _{2.09}	225.0841	100	N.A.	0	5.89
Ag _{0.88} Sb _{1.12} Te _{2.12}	225.4260	100	N.A.	0	3.1
Ag _{0.85} Sb _{1.15} Te _{2.15}	224.7639	100	N.A.	0	3.9
Ag _{0.82} Sb _{1.18} Te _{2.18}	224.9342	81.87	461.9025	18.13	4.85
Ag _{0.79} Sb _{1.21} Te _{2.21}	225.2061	93.19	458.813	6.81	4.21

and quenching showing fraction of Sb₂Te₃.

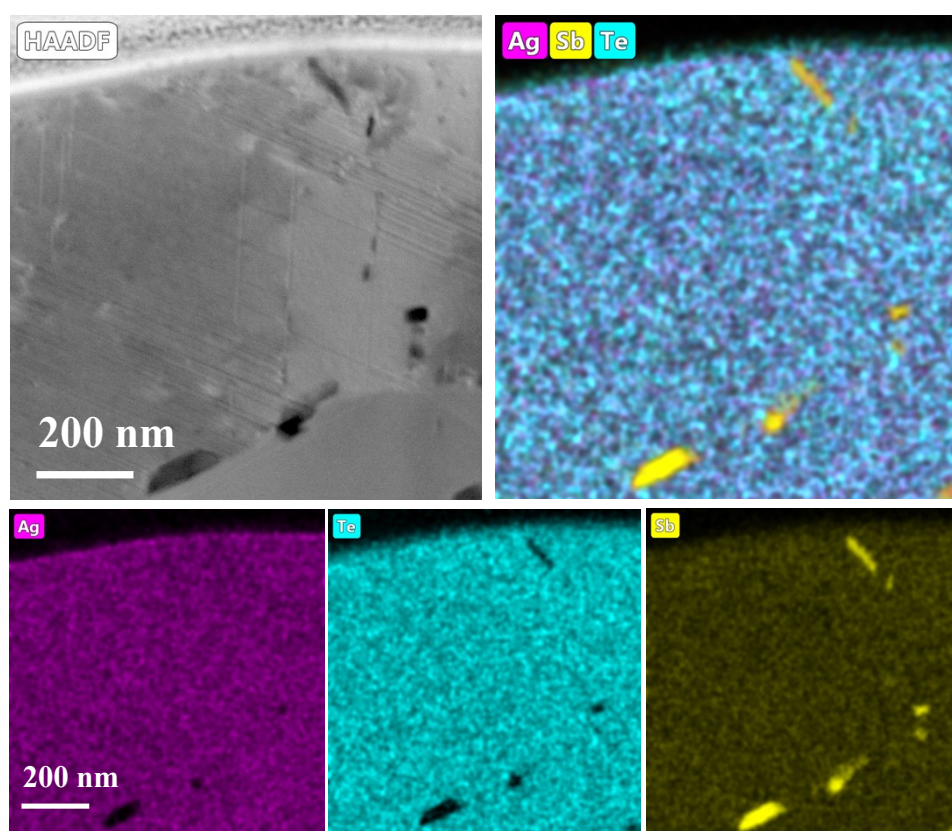


Figure S1. HAADF and EDS from HRTEM of Ag_{0.79}Sb_{1.21}Te_{2.21} showing small amount of Sb-rich regions.

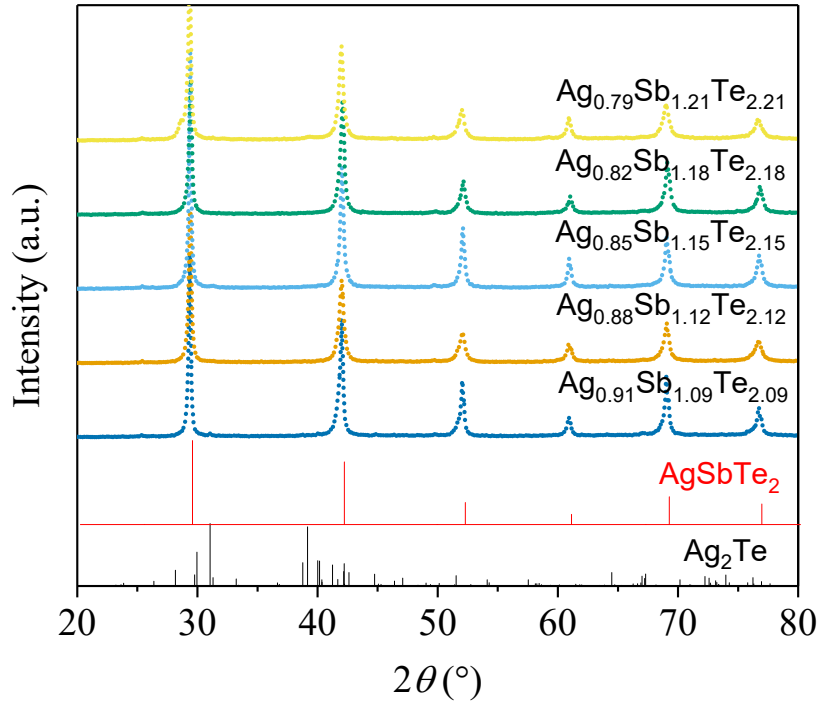


Figure S2. XRD (x-ray diffraction) for samples without thermal annealing and quenching.

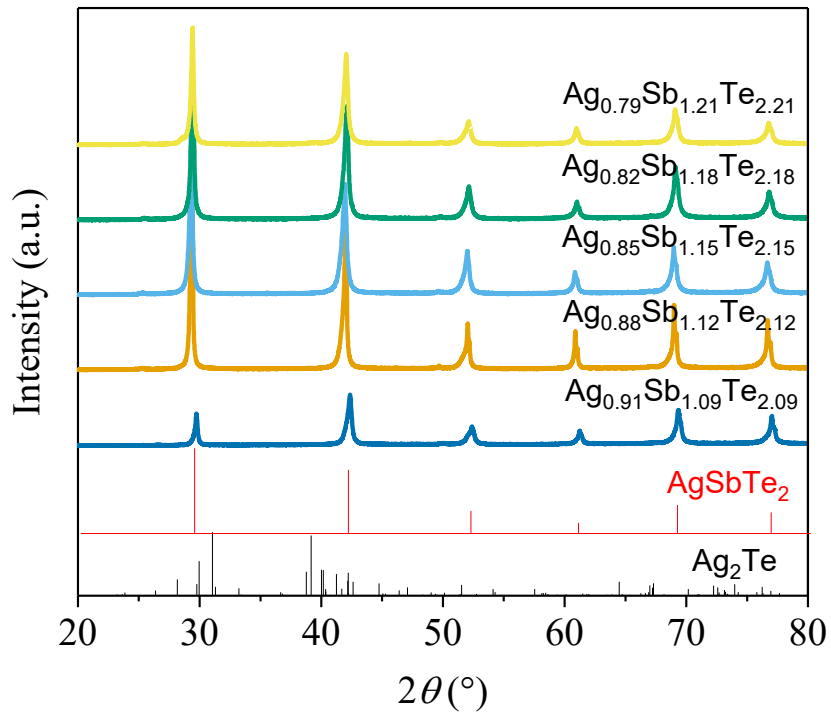


Figure S3. XRD (x-ray diffraction) for all samples annealed at 773 K followed by quenching after transport properties testing.

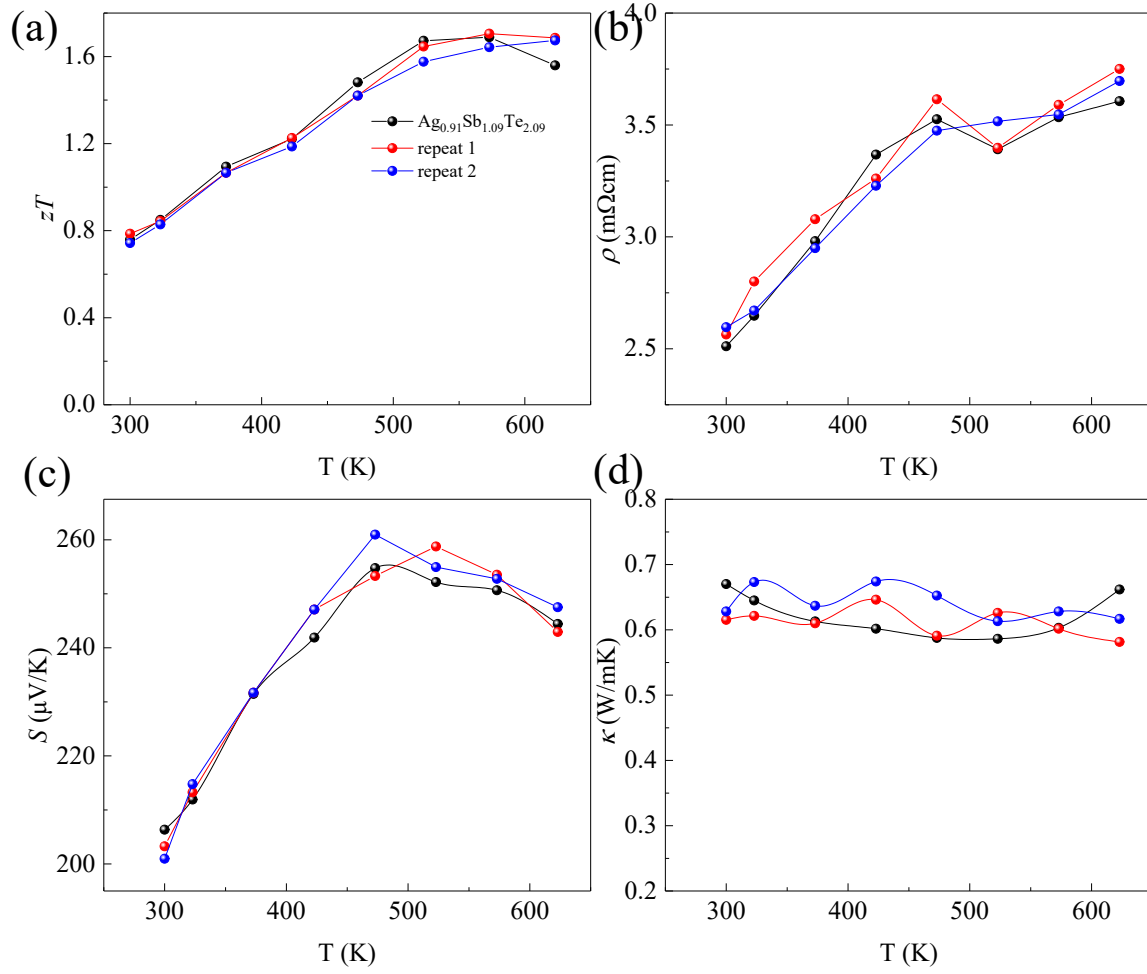


Figure S4. Cyclic testing of heating-cooling for $\text{Ag}_{0.91}\text{Sb}_{1.09}\text{Te}_{2.09}$ sample (a) zT (b) electrical resistivity (c) Seebeck coefficient and (d) thermal conductivity.

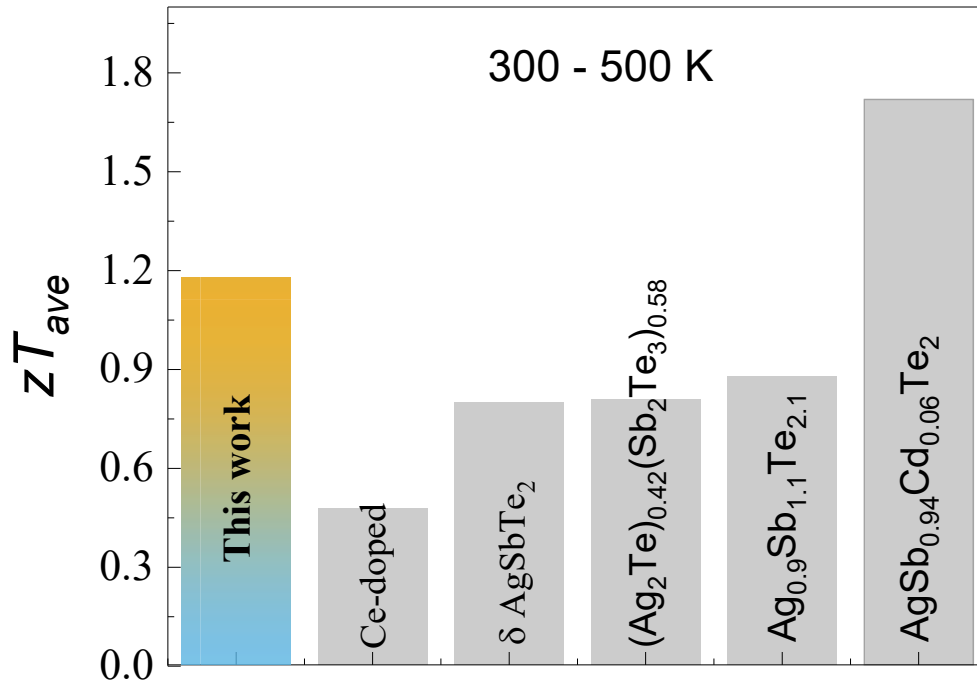


Figure S5. Literature comparison of average zT in this work with literatures between 300 – 500 K.¹⁻⁴

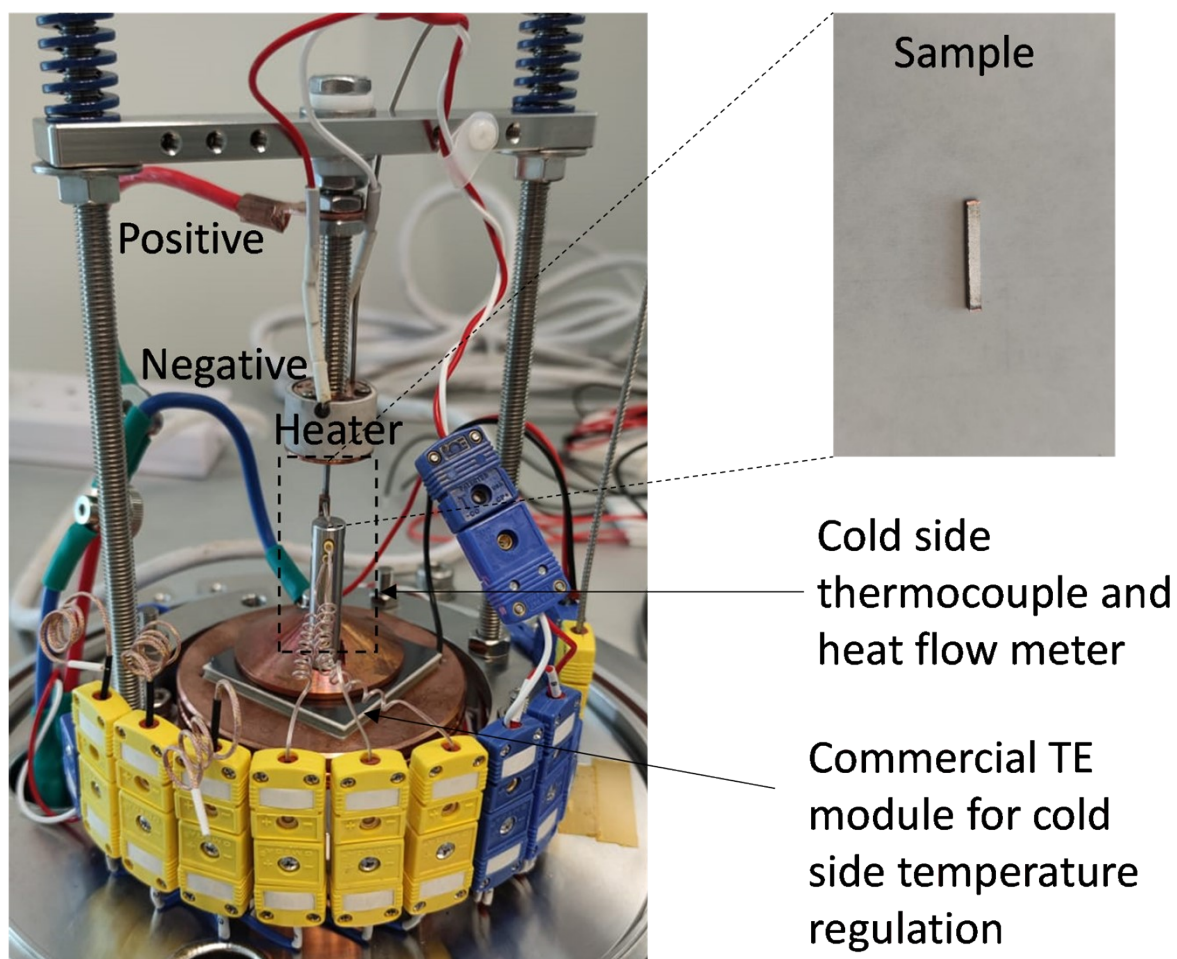


Figure S6. Single leg setup schematic.

References

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